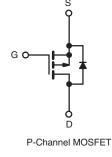


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 100				
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.20			
Q _g (Max.) (nC)	61				
Q _{gs} (nC)	14				
Q _{gd} (nC)	29				
Configuration	Single				





FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package	D ² PAK (TO-263)	D ² PAK (TO-263)				
Lead (Pb)-free and Halogen-free	SiHF9540S-GE3	SiHF9540STRL-GE3ª				
Load (Bb) free	IRF9540SPbF	IRF9540STRLPbF ^a				
Lead (Pb)-free	SiHF9540S-E3	SiHF9540STL-E3 ^a				

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unless otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	- 100			
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current	$T_{\rm C} = 25 ^{\circ}{\rm C}$	I _D -	- 19		
Continuous Drain Current	V_{GS} at - 10 V $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		- 13	А	
Pulsed Drain Current ^a	•	I _{DM}	- 72	1	
Linear Derating Factor			1.0	W/°C	
Linear Derating Factor (PCB Mount) ^e		0.025	VV/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	640	mJ	
Repetitive Avalanche Current ^a	I _{AR}	- 19	A		
Repetitive Avalanche Energy ^a		E _{AR}	15	mJ	
Maximum Power Dissipation	T _C = 25 °C	D	150	w	
Maximum Power Dissipation (PCB Mount)e	$1_{\rm C} = 25$ C	P _D	3.7	7 **	
Peak Diode Recovery dV/dtc	dV/dt	- 5.5	V/ns		
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 175	- °C		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 2.7 mH, R_g = 25 Ω , I_{AS} = - 19 A (see fig. 12).

c. $I_{SD} \le -19$ A, dI/dt ≤ 200 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material)

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	1.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	TES	TEST CONDITIONS			MAX.	UNIT	
Static		*		•	•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = - 250 μΑ	- 100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	-	- 0.087	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS}=V_{GS},I_{D}=-250\;\mu\text{A}$			- 4.0	V
Gate-Source Leakage	I _{GSS}		-	-	± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}		V _{DS} = - 100 V, V _{GS} = 0 V V _{DS} = - 80 V, V _{GS} = 0 V, T _J = 150 °C			- 100 - 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 11 A ^b	-	-	0.20	Ω
Forward Transconductance		V _{DS} =	- 50 V, I _D = - 11 A	6.2	-	-	S
Dynamic	-						1
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1400	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V,$	-	590	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	140	-	
Total Gate Charge	Qg			-	-	61	nC
Gate-Source Charge	Q_gs	V _{GS} = - 10 V	$I_D = -19 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13^{b}	-	-	14	
Gate-Drain Charge	Q _{gd}		see lig. o and ro	-	-	29	
Turn-On Delay Time	t _{d(on)}			-	16	-	- ns
Rise Time	t _r	V _{DD} =	- 50 V, I _D = - 19 A,	-	73	-	
Turn-Off Delay Time	t _{d(off)}	R _G = 9.1 Ω,	$R_D = 2.4 \ \Omega$, see fig. 10^b	-	34	-	
Fall Time	t _f			-	57	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") t	from	-	4.5	-	nH
Internal Source Inductance	L _S	package and die contact	package and center of		7.5	-	1111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	- 19	A
Pulsed Diode Forward Current ^a	I _{SM}				-	- 72	~
Body Diode Voltage	V_{SD}	T _J = 25 °C	, I _S = - 19 A, V _{GS} = 0 V ^b	-	-	- 5.0	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C J	= - 19 A, dl/dt = 100 A/µs ^b	-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 23$ C, I _F	$= -10 \text{ A}, \text{ u/u} = 100 \text{ A/}\mu\text{S}^{\circ}$	-	0.35	0.70	nC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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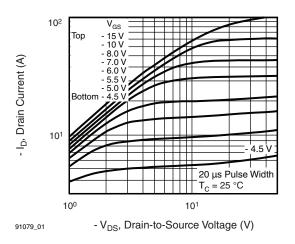


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

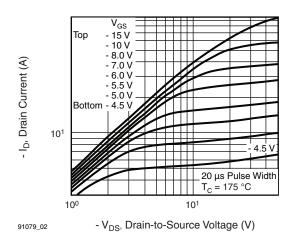


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^{\circ}C$

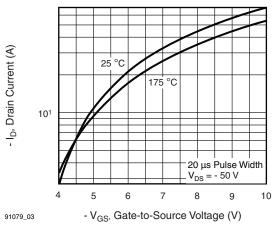


Fig. 3 - Typical Transfer Characteristics

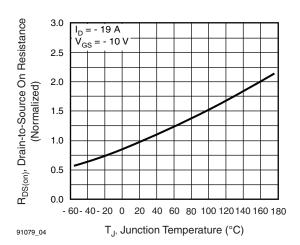


Fig. 4 - Normalized On-Resistance vs. Temperature

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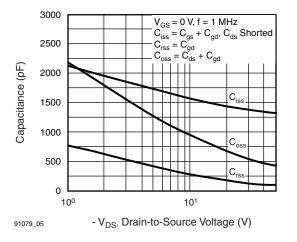


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

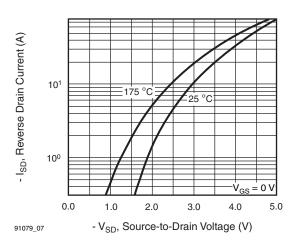


Fig. 7 - Typical Source-Drain Diode Forward Voltage

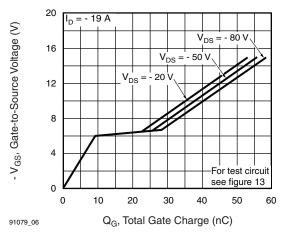


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

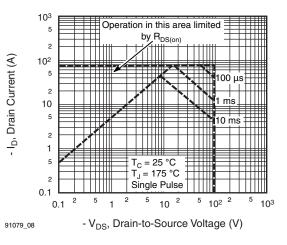


Fig. 8 - Maximum Safe Operating Area

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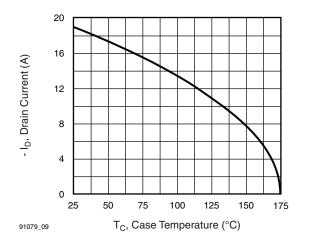


Fig. 9 - Maximum Drain Current vs. Case Temperature

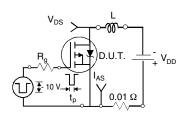


Fig. 10a - Switching Time Test Circuit

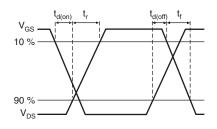


Fig. 10b - Switching Time Waveforms

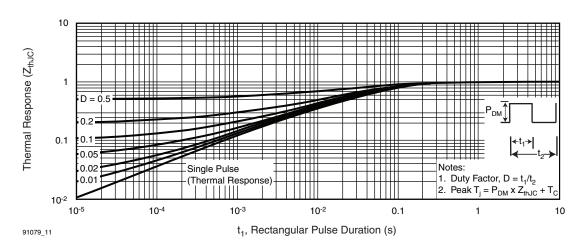


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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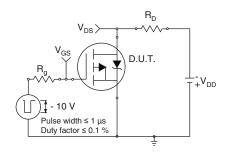


Fig. 12a - Unclamped Inductive Test Circuit

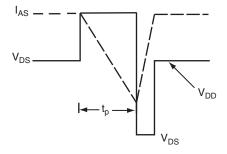


Fig. 12b - Unclamped Inductive Waveforms

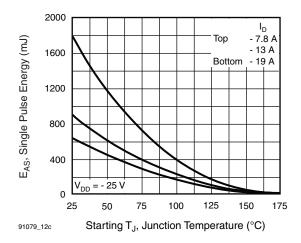
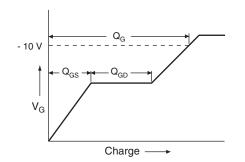


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





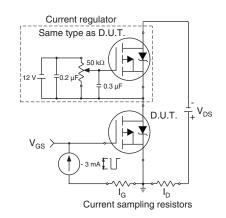


Fig. 13b - Gate Charge Test Circuit

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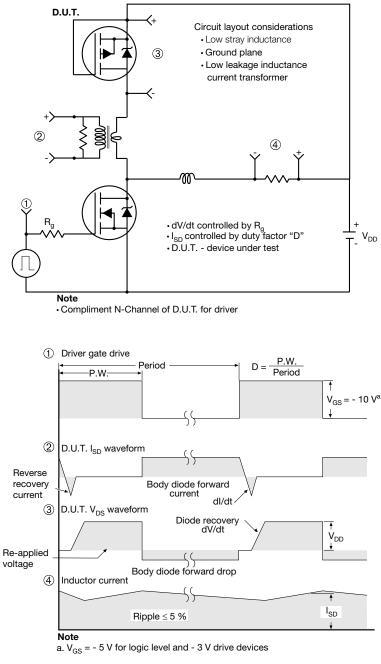


Fig. 14 - For P-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>		
	MILLIN	IETERS	INCHES				MILLIN	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
				0.010		-		10.07	0.000	0.420	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120	
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-	
							6.22	- 10.67 - BSC	0.245	- BSC	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625	
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110	
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066	
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070	

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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